

N-Channel Power MOSFET

600V, 24A, 165mΩ

FEATURES

- Super-Junction technology
- High performance, small $R_{DS(on)} * Q_g$ figure of merit (FOM)
- High ruggedness performance
- 100% UIS & R_g tested
- High commutation performance
- ROHS Compliant
- Halogen-free according to IEC 61249-2-21

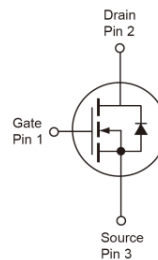
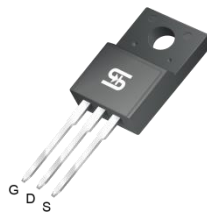
KEY PERFORMANCE PARAMETERS		
PARAMETER	VALUE	UNIT
V_{DS}	600	V
$R_{DS(on)}$ (max)	165	mΩ
Q_g	44	nC

APPLICATIONS

- Power Supply
- AC/DC LED Lighting



ITO-220



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current (Note 1)	I_D	$T_C = 25^\circ\text{C}$	24
		$T_C = 100^\circ\text{C}$	15
Pulsed Drain Current (Note 2)	I_{DM}	72	A
Total Power Dissipation @ $T_C = 25^\circ\text{C}$	P_D	89	W
Single Pulse Avalanche Energy (Note 3)	E_{AS}	450	mJ
Single Pulse Avalanche Current (Note 3)	I_{AS}	4.2	A
Operating Junction and Storage Temperature Range	T_J, T_{STG}	- 55 to +150	$^\circ\text{C}$

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction to Case Thermal Resistance	$R_{\theta JC}$	1.4	$^\circ\text{C/W}$
Junction to Ambient Thermal Resistance	$R_{\theta JA}$	60	$^\circ\text{C/W}$

Note: $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. $R_{\theta JA}$ is guaranteed by design while $R_{\theta JC}$ is determined by the user's board design.

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static (Note 4)						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 1mA$	BV_{DSS}	600	--	--	V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1mA$	$V_{GS(TH)}$	3	3.9	5	V
Gate Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	I_{GSS}	--	--	± 100	nA
Zero Gate Voltage Drain Current	$V_{DS} = 600V, V_{GS} = 0V$	I_{DSS}	--	--	100	μA
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 11.3A$	$R_{DS(on)}$	--	150	165	m Ω
Dynamic (Note 5)						
Total Gate Charge	$V_{DS} = 300V, I_D = 24A,$ $V_{GS} = 10V$	Q_g	--	44	--	nC
Gate-Source Charge		Q_{gs}	--	13	--	
Gate-Drain Charge		Q_{gd}	--	18	--	
Input Capacitance	$V_{DS} = 300V, V_{GS} = 0V,$ $f = 1.0MHz$	C_{iss}	--	1857	--	pF
Output Capacitance		C_{oss}	--	53	--	
Reverse Transfer Capacitance		C_{rss}	--	13	--	
Gate Resistance	$f = 1.0MHz$	R_g	--	1.6	3.2	Ω
Switching (Note 6)						
Turn-On Delay Time	$V_{DD} = 300V, R_G = 10\Omega,$ $I_D = 15A, V_{GS} = 10V$	$t_{d(on)}$	--	30	--	ns
Turn-On Rise Time		t_r	--	50	--	
Turn-Off Delay Time		$t_{d(off)}$	--	60	--	
Turn-Off Fall Time		t_f	--	12	--	
Source-Drain Diode (Note 4)						
Body-Diode Continuous Forward Current		I_S	--	--	20	A
Body-Diode Pulsed Current		I_{SM}	--	--	60	A
Forward Voltage	$I_S = 20A, V_{GS} = 0V$	V_{SD}	--	0.9	1.4	V
Reverse Recovery Time	$I_S = 20A$	t_{rr}	--	410	--	ns
Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	Q_{rr}	--	8.5	--	μC

Notes:

- Current limited by package.
- Pulse width limited by the maximum junction temperature.
- $L = 50mH, I_{AS} = 4.2A, V_{DD} = 50V, R_G = 25\Omega,$ Starting $T_J = 25^\circ\text{C}$
- Pulse test: $PW \leq 300\mu s,$ duty cycle $\leq 2\%$.
- For DESIGN AID ONLY, not subject to production testing.
- Switching time is essentially independent of operating temperature.

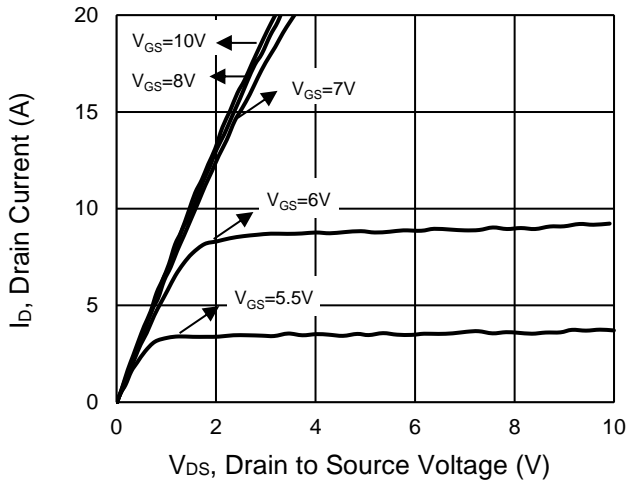
ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
TSM60NC165CI C0G	ITO-220	50pcs / Tube

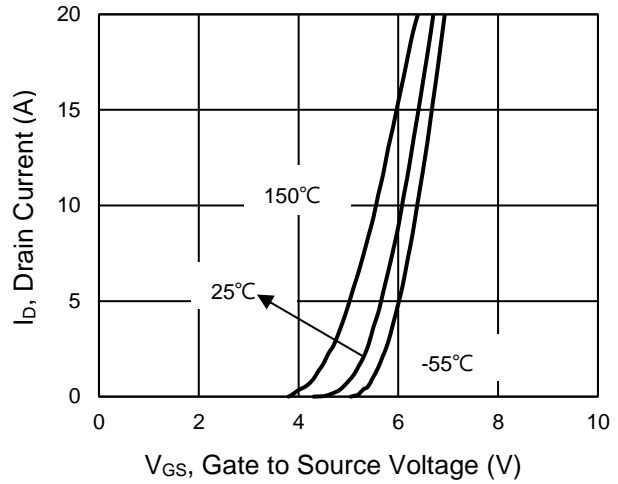
CHARACTERISTICS CURVES

($T_c = 25^\circ\text{C}$ unless otherwise noted)

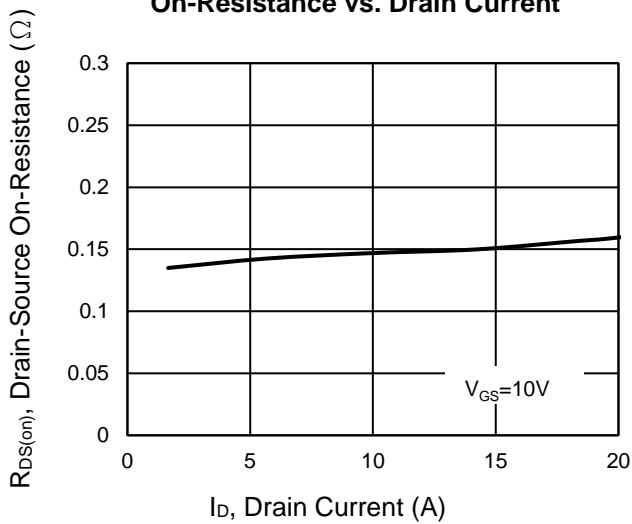
Output Characteristics



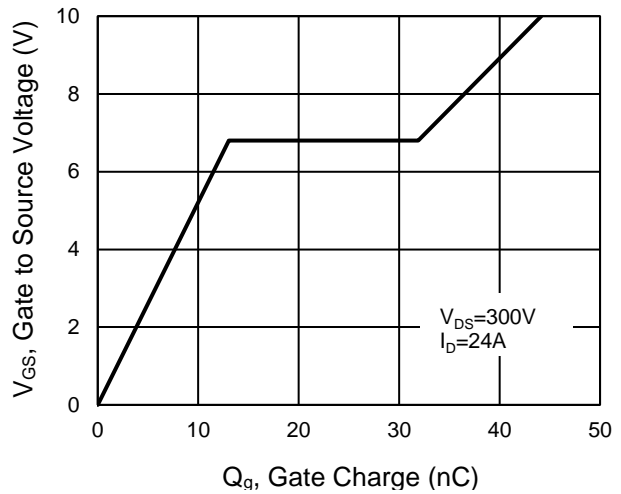
Transfer Characteristics



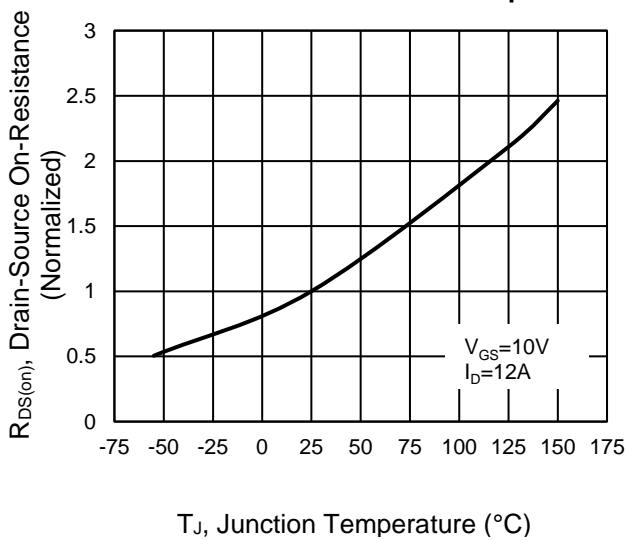
On-Resistance vs. Drain Current



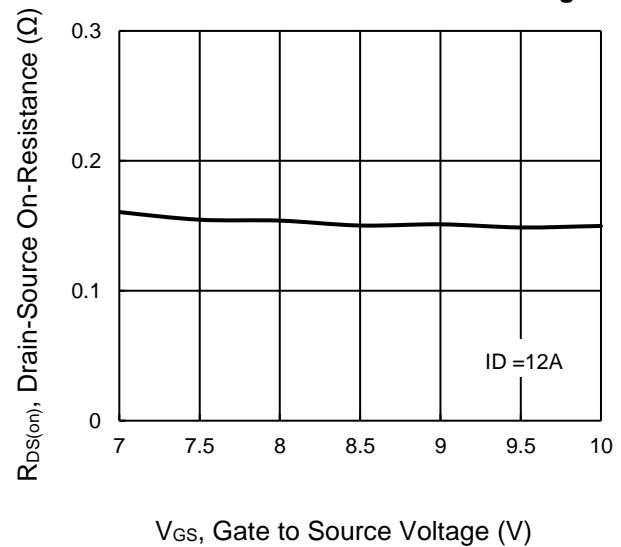
Gate-Source Voltage vs. Gate Charge



On-Resistance vs. Junction Temperature



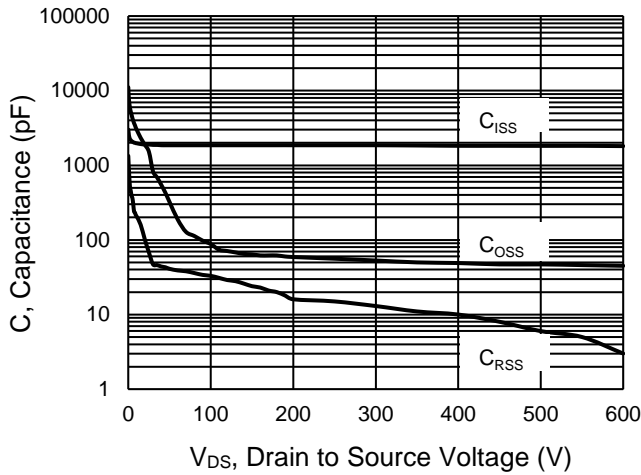
On-Resistance vs. Gate-Source Voltage



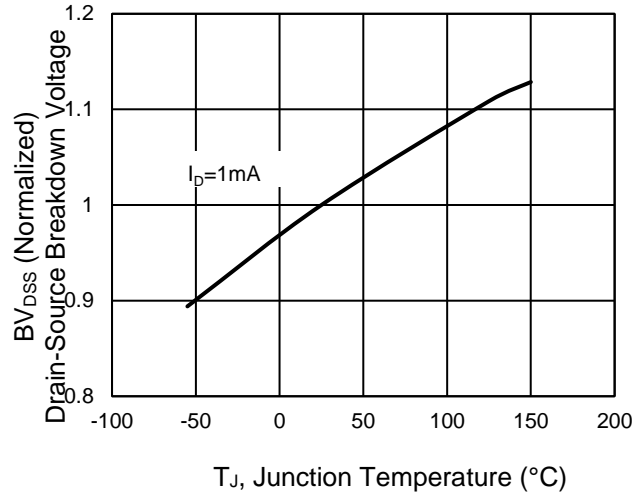
CHARACTERISTICS CURVES

($T_c = 25^\circ\text{C}$ unless otherwise noted)

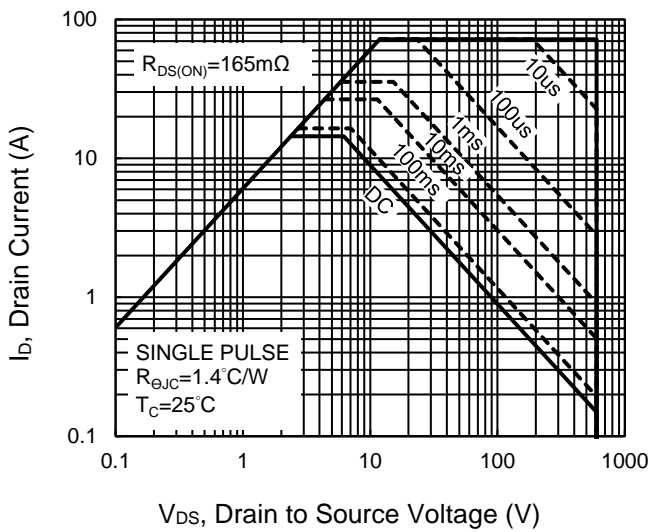
Capacitance vs. Drain-Source Voltage



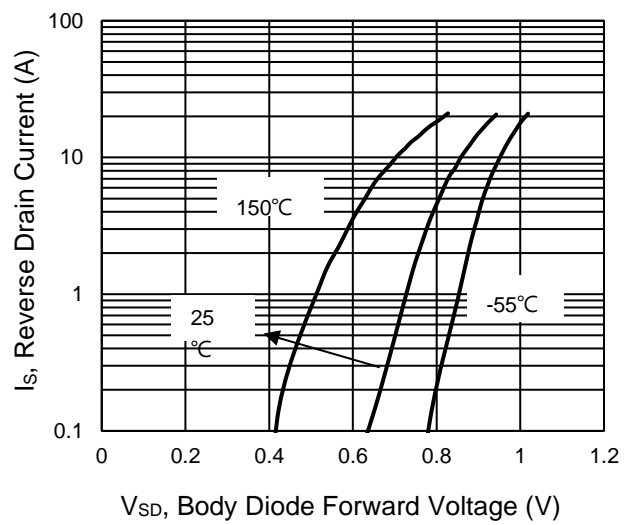
BV_{DSS} vs. Junction Temperature



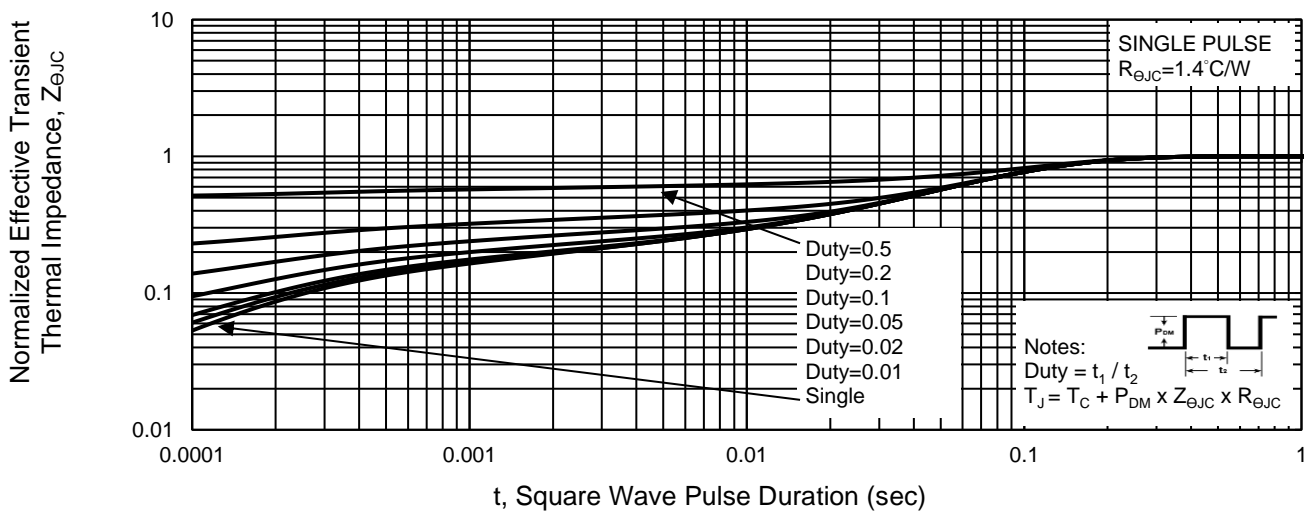
Maximum Safe Operating Area, Junction-to-Case



Source-Drain Diode Forward Current vs. Voltage

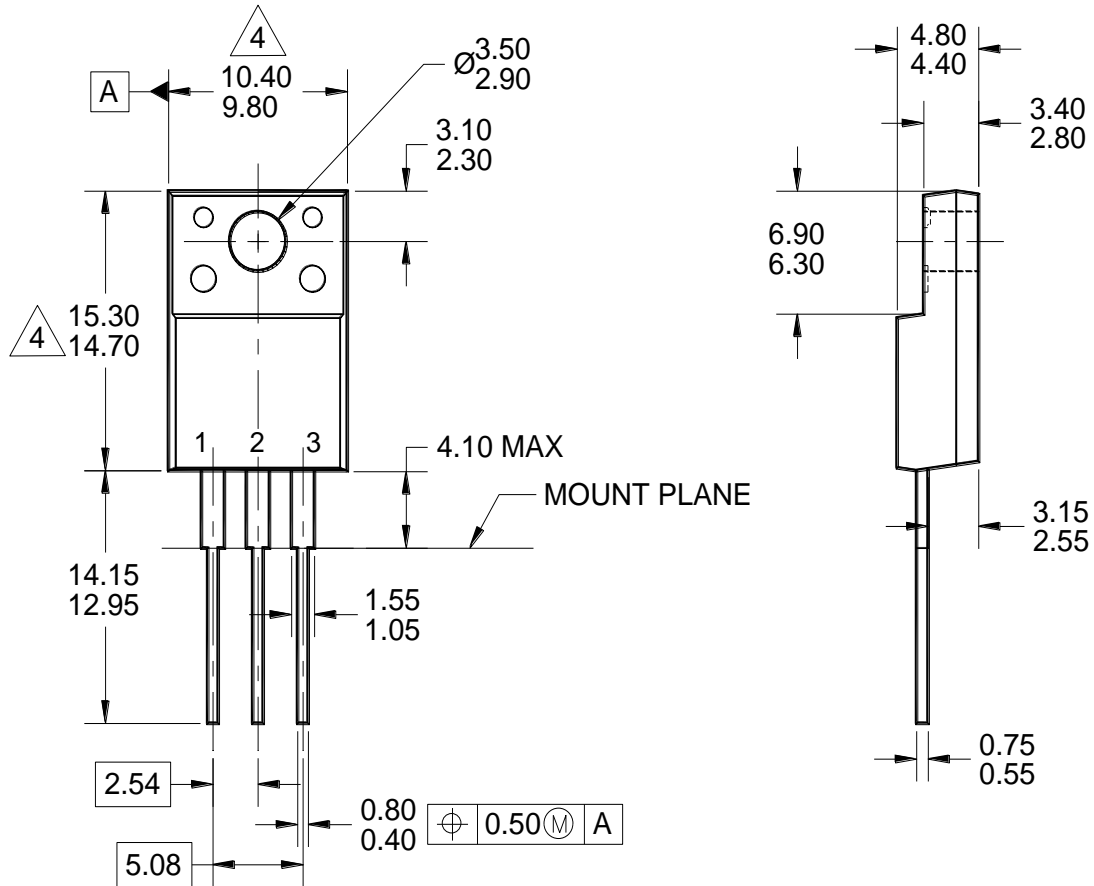


Normalized Thermal Transient Impedance, Junction-to-Case



PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

ITO-220

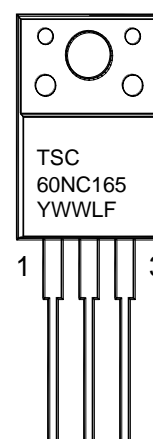


NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: EIAJ ED-7500A-1, SC-91.

4 MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.

5. DWG NO. REF: HQ2SD07-ITO220-072 REV A.



MARKING DIAGRAM

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|-----|-----------------------|
| P/N | = MARKING CODE |
| Y | = YEAR CODE |
| WW | = WEEK CODE (01 ~ 52) |
| L | = LOT CODE (1~9, A~Z) |
| F | = FACTORY CODE |

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